

# 3030 1W LED Datasheet



## **Features:**

Slim Size SMD Package: Design Flexibility
High Lumen Output and High Efficacy
Stable Performance & Great CCT Unity
Wide Color Temperature Range
High CRI, can reach 90
Environmental Friendly; ROHS Compliance
Customized Service Available

# **Applications:**

LED Module, Illuminated Advertising

Tube Light, Panel Light, Ceiling Lamp and other LED Indoor Lights

Flood Light, High Bay Light, Tunel Light and other LED Outdoor Lights

LED Aquarium Light, LED Plant Growing Light..

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## **PRODUCT NAMING RULES**

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## **CHARACTERISTICS**

# SPECIFICATIONS (Ta=25 $^{\circ}$ C)

Norminal CCT	Color Rendering	Forward Voltage (V)	Forward Current (mA)	Luminous Flux (LM)	Part Number	
2900-3200К	70	5.8-6.4	150	110-120	LKL-3030W320110R7	
4000-4500K	70	5.8-6.4	150	110-120	LKL-3030W420110R7	
6000-6500K	70	5.8-6.4	150	110-120	LKL-3030W620110R7	
2900-3200К	80	5.8-6.4	150	120-130	LKL-3030W320120R8	
4000-4500K	80	5.8-6.4	150	120-130	LKL-3030W420120R8	
6000-6500K	80	5.8-6.4	150	120-130	LKL-3030W620120R8	
2900-3200К	80	5.8-6.4	150	130-140	LKL-3030W320130R8	
4000-4500K	80	5.8-6.4	150	130-140	LKL-3030W420130R8	
6000-6500K	80	5.8-6.4	150	130-140	LKL-3030W620130R8	
2900-3200К	80	5.8-6.4	150	140-150	LKL-3030W320140R8	
4000-4500K	80	5.8-6.4	150	140-150	LKL-3030W420140R8	
6000-6500K	80	5.8-6.4	150	140-150	LKL-3030W620140R8	



## **CHARACTERISTICS**

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Absolute Maximum	natiligs at 1	1–23 C

Symbol	Maximum Performance
I <sub>F</sub>	150mA
I <sub>FP</sub>	200mA
P <sub>D</sub>	1050mW
V <sub>R</sub>	5V
2θ 1/2	120°
T <sub>OPR</sub>	-40 ~ +105°C
T <sub>STG</sub>	-40 ~ +85°C
T <sub>j</sub>	125°C
T <sub>SLD</sub>	Reflow Soldering: 230°C or 260°C for 10Sec
	$I_{F}$ $I_{FP}$ $P_{D}$ $V_{R}$ $2\theta \ 1/2$ $T_{OPR}$ $T_{STG}$ $T_{j}$

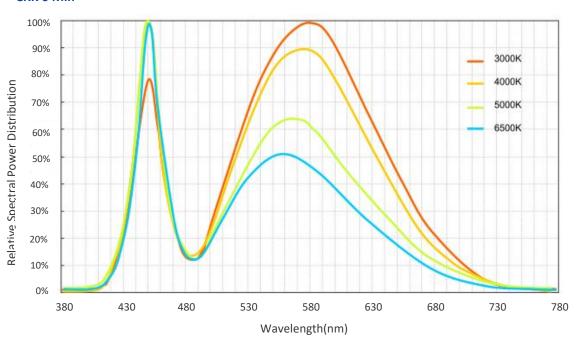
Electrical/	Optical Cha	ractoristics	+ T:-2F°C
			. al II=25 L

Parameters	Symbol	Min	Туре	Max	Unit	Condition
Forward Voltage	V <sub>F</sub>	5.6	6.0	6.2	V	IF=150mA
Reverse Current	IR		10		μΑ	VR=5V
Thermal Resistance	Rth j-sp		12		°C/W	IF=150mA
Electrostatic Discharge	ESD	2000			V	НВМ

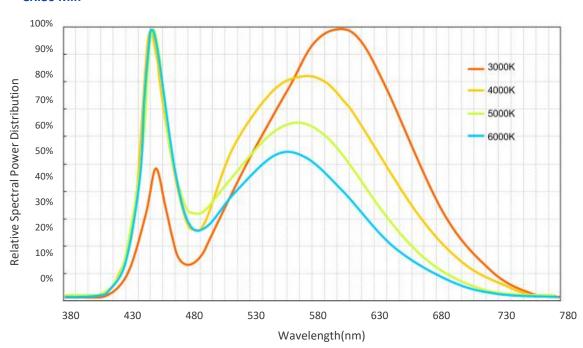


#### **RELATIVE SPECTRAL POWER DISTRIBUTION**

## **CRI70 Min**



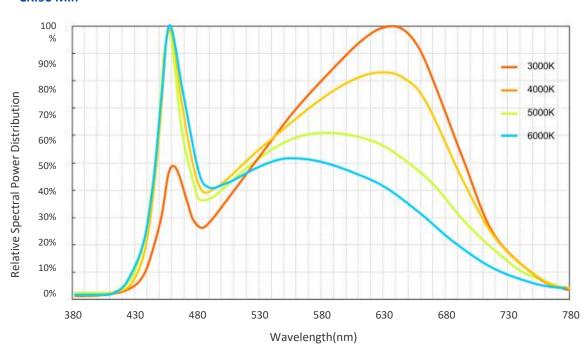
#### **CRI80 Min**



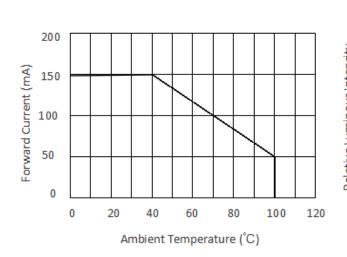


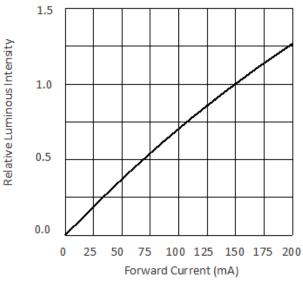
#### **RELATIVE SPECTRAL POWER DISTRIBUTION**

## CRI90 Min



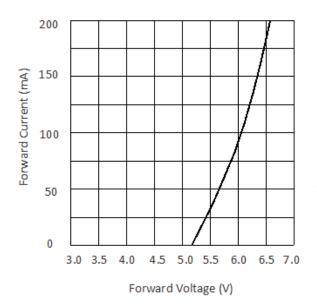
## **TYPICAL CHARACTERISTIC CURVES**

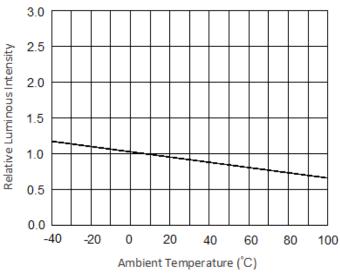




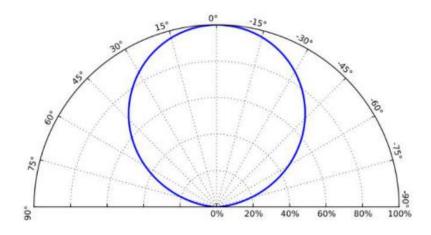


## **TYPICAL CHARACTERISTIC CURVES**



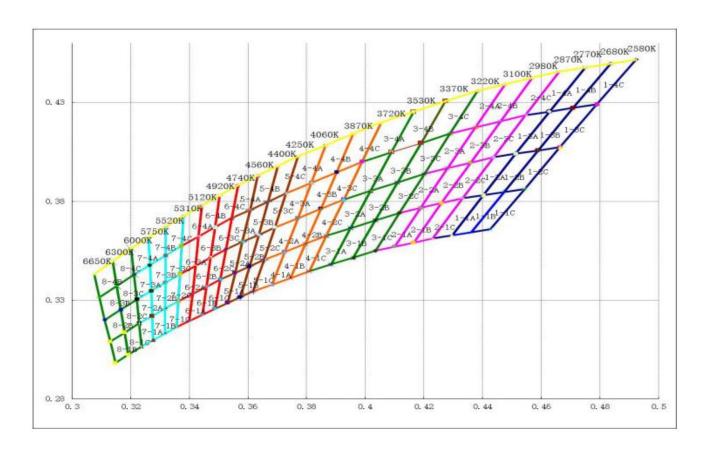


## Intensity Distribution Diagram





#### **CIE BINNING INFORMATION**





#### **RELIABILITY TESTS**

Test Items	Test Conditions	Sample QTY	Ac/Re
Aging Tost	IF=150mA, Ta=25 °C x6000hrs	22	0/1
Aging Test	IF=150mA, Ta=85 °C x6000hrs	22	0/1
High Temperature Storage	100℃ x1000hrs	22	0/1
Low Temperature Storage	-40℃ x1000hrs	22	0/1
High Temp & Humidity	IF=150mA, 85℃, 85% RH for 6000hrs	22	0/1
Temperature Shock	-40°Cx30 min & +100°Cx30 min, 100cycle	22	0/1
ESD(HBM)	2000V HBM/ 1 Time	10	0/1

# Criteria for Judging LED Failure (Tc= 25°C)

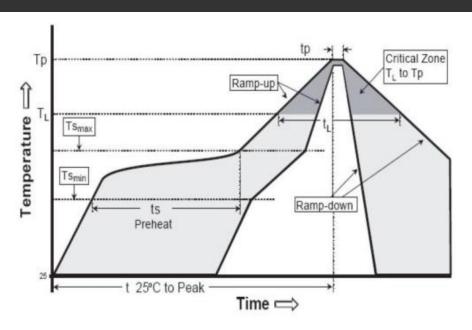
Items	Symbol	Test Conditions	Criteria for Judging LED Failure
Forward Voltage	VF	IF=150mA	>U x 1.1
Reverse Current	IR	VR=5V	IR>/= 10μA
Lumen	ФV	IF=150mA	<s 0.7<="" td="" x=""></s>

U refers to max value; S refers to initial value.



#### **TYPICAL CHARACTERISTIC CURVES**

## **REFLOW SOLDERING PROFILE**

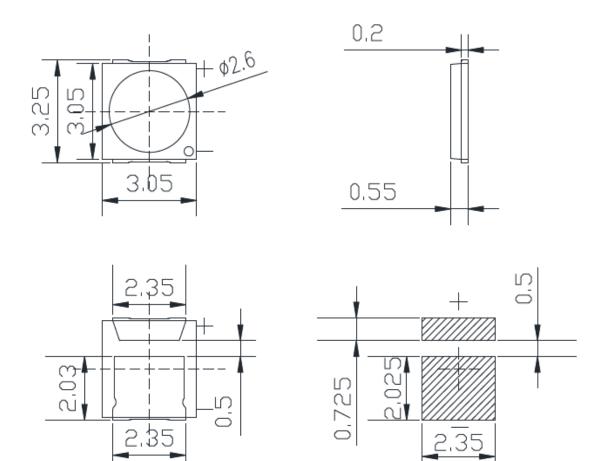


Profile Features	Lead-free solder	Lead solder	Soldering by Manual
Ramp-up Speed(Ts max to Tp)	3 °C/ second max.	3 °C/ second max.	
Preheat: Min. Temperature(Tsmin)	150 °C	100 °C	
Preheat: Max.Temperature(Tsmax)	200 °C	150 °C	
Preheat: Time (tsmin to tsmax)	60~180 seconds	60~120 seconds	
Temperature to Keep: (TL)	217 °C	183 °C	Max. temperature: 350°C
Time to Keep: (tL)	60~150 seconds	60~150 seconds	3 seconds/1 time
Peak Temperature (Tp)	260 °C	215 °C	
temperature	20~40 seconds	10~30 seconds	
Ramp-down Speed	6°C/ second max.	6°C/ second max.	
Time to the peak Temperature	8 minutes max.	6 minutes max.	



#### **DIMENSIONS**

Unit: mm



## Notes:

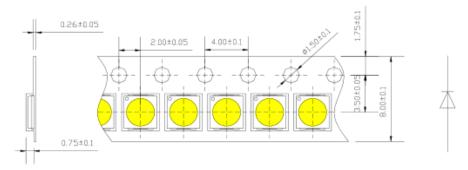
\*All dimensions are in millimeters.(tolerance:±0.2mm)

\*The appearance and specifications of the product may be changed for improvement without notice.

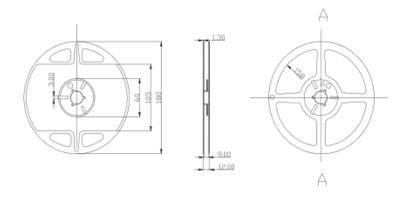


## **PACKAGING**

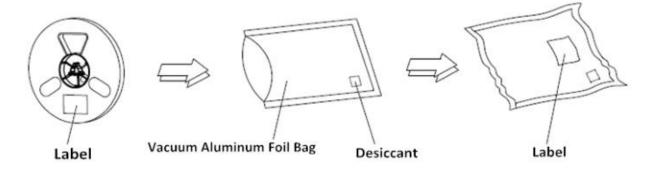
Tape Specifications (Units: mm)



## **Reel Dimensions**



## Moisture Resistant Packaging





#### **PRECAUTIONS**

#### Storage

- 1. Moisture proof and anti-electrostatic package with moisture absorbent material is used, to keep moisture to aminimum.
- 2. Before opening the package, the product should be kept at 30 °C or less and humidity less than 60% RH, and beused within a year.
- 3. After opening the package, the product should be stored at  $30^{\circ}$ C or less and humidity less than 10%RH, and besoldered within 24 hrs (1day). It is recommended that the product be operated at the workshop condition of  $30^{\circ}$ C or less and humidity less than 60%RH.
- 4. If the moisture absorbent material has fade away or the LEDs have exceeded the storage time, baking treatment should be performed based on the following condition: (80±5) °C for 24 hours.

#### **Static Electricity**

- 1. Static electricity or surge voltage damages the LEDs. Damaged LEDs will show some unusual characteristic such as the forward voltage becomes lower, or the LEDs do not light at the low current. even not light.
- 2. All devices, equipment and machinery must be properly grounded. At the same time, it is recommended that wrist bands or anti-electrostatic gloves, anti-electrostatic containers be used when dealing with the LEDs.

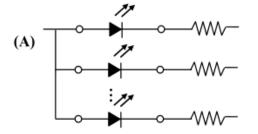
#### **Vulcanization**

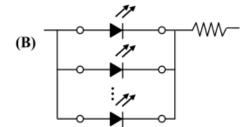
LED curing is due to sulfur being in bracket and the +1 price of silver in the chemical reaction generated Ag2S in the process. It will lead to the capacity of reflecting of silver layer reducing, light color temperature drift and serious decline, seriously affecting the performance of the product. So we should take corresponding measures to avioding vulcanization, such as to avoid using sulphur volatile substances and keeping away from high sulphur content of the material.

#### **Design Consideration**

- 1. In designing a circuit, the current through each LED must not exceed the absolute maximum rating specified for each LED. In the meanwhile, resistors for protection should be applied, otherwise slight voltage shift will cause big current change, burn out may happen.
- 2. It is recommended to use Circuit A which regulates the current flowing through each LED rather than Circuit B.

  When driving LEDs with a constant voltage in Circuit B, the current through the LEDs may vary due to the variation in Forward Voltage (VF) of the LEDs. In the worst case, some LED may be subjected to stresses in excess of the Absolute Maximum Rating.





3. Thermal Design is paramount importance because heat generation may result in the Characteristics decline, such as brightness decreased, Color changed and so on. Please consider the heat generation of the LEDs when making the system design.



#### **PRECAUTIONS**

#### **Safety Advice For Human Eyes**

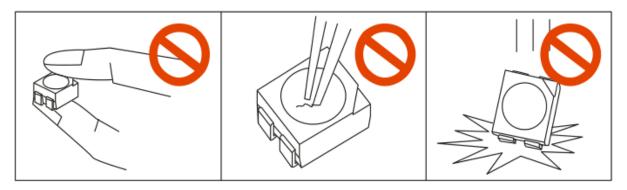
Viewing direct to the light emitting center of the LEDs, especially those of great Luminous Intensity will cause great hazard to human eyes. Please be careful.

#### The safe temperature for LEDs working

The high temperature will make the LEDs' Luminous Intensity decreased radically, if LEDs worked in hoteyes. Please be careful. environment for a long time, they will be disabled easily. When LEDs are working in a closed array, we suggest that the LEDs' surface temperature should be lower than  $55^{\circ}$ C and the legs' temperature should be lower than  $75^{\circ}$ C.

#### Others

1. When handling the product, touching the encapsulant with bare hands will not only contaminate its surface, but also affect on its optical characteristics. Excessive force to the encapsulant might result in catastrophic failure of the LEDs due to Die breakage or wire deformation. For this reason, please do not put excessive stress on LEDs, especially when the LEDs are heated such as during Reflow Soldering.



2. The epoxy resin of encapsulant is fragile, so please avoid scratch or friction over the epoxy resin surface. While handling the product with tweezers, do not hold by the epoxy resin, be careful.